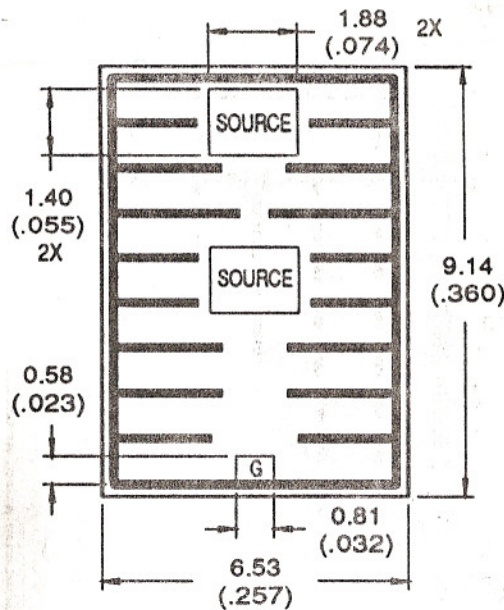




# Sierra Components, Inc.

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Phone: 775.783.4940 Fax: 775.783.4947

Chip back potential is the level which bulk silicon is maintained by on-chip connection, or it is the level to which the chip back must be connected when specifically stated below.



**Topside Metal: Aluminum**

**Backside: TiNiAg**

**Backside Potential: Drain**

**Mask Ref: Issue 1**

**Bond Pads (Mils): See Above**

**APPROVED BY:**

**MFG: IRI**

**DIE SIZE: .257" X .360"**

**THICKNESS: .014"**

**DATE: 11/24/99**

**P/N: IRFC260**